



DIM. MIN. TYP. MAX.

* A	0.697 (17.70)		0.711 (18.06)
* B	0.286 (7.26)		0.299 (7.59)
C	0.088 (2.24)		0.105 (2.67)
E	0.390 (9.90)		0.419 (10.64)
F		0.650 (16.51)	
H	0.003 (0.08)		0.020 (0.51)
J	0.013 (0.33)		0.018 (0.46)
K		0.041 (1.04)	
K1		0.041 (1.04)	
L	0.016 (0.41)		0.050 (1.27)
P		0.050 (1.27)	
T	0.009 (0.23)		0.0125 (0.32)
W		45°	
X	0°		10°
Y		7°	

NOTE :

* A & B are reference datum's and do not include mold deflash or protrusions.

All dimensions in inches (mm.)
Angles are in degrees

Co-Planarity of leads within 0.004" (0.1mm)

TITLE 28-pin SOIC Package (Wide)	DRAWING No. D1.CDR	
	D'WN S.D.F.	© C.M.L. 2003
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